International

SMPS MOSFET

V_{DSS}

200V

PD-95354A

 I_D

13A

IRFR13N20DPbF IRFU13N20DPbF

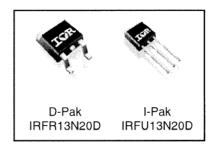
HEXFET[®] Power MOSFET

| App | lications |
|-----|-----------|
|-----|-----------|

- High frequency DC-DC converters
- Lead-Free

Benefits

- Low Gate to Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective C_{OSS} to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage
 and Current



R_{DS(on)} max

0.235Ω

| | Parameter | Max. | Units |
|---|---|------------------------|-------|
| I _D @ T _C = 25°C | Continuous Drain Current, V _{GS} @ 10V | 13 | |
| I _D @ T _C = 100°C | Continuous Drain Current, V _{GS} @ 10V | 9.2 | A |
| I _{DM} | Pulsed Drain Current ① | 52 | |
| P _D @T _C = 25°C | Power Dissipation | 110 | W |
| | Linear Derating Factor | 0.71 | W/°C |
| V _{GS} | Gate-to-Source Voltage | ± 30 | V |
| dv/dt | Peak Diode Recovery dv/dt 3 | 2.2 | V/ns |
| TJ | Operating Junction and | -55 to + 175 | |
| T _{STG} | Storage Temperature Range | | °C |
| | Soldering Temperature, for 10 seconds | 300 (1.6mm from case) | |

Absolute Maximum Ratings

Typical SMPS Topologies

• Telecom 48V input Forward Converters

Notes ① through ⑥ are on page 10 www.irf.com

Static @ T_J = 25°C (unless otherwise specified)

| | Parameter | Min. | Тур. | Max. | Units | Conditions |
|-----------------------------------|--------------------------------------|------|------------|-------|-------|--|
| V _{(BR)DSS} | Drain-to-Source Breakdown Voltage | 200 | | | V | $V_{GS} = 0V, I_D = 250 \mu A$ |
| $\Delta V_{(BR)DSS} / \Delta T_J$ | Breakdown Voltage Temp. Coefficient | | 0.25 | | V/°C | Reference to 25°C, I _D = 1mA |
| R _{DS(on)} | Static Drain-to-Source On-Resistance | | | 0.235 | Ω | $V_{GS} = 10V, I_D = 8.0A$ ④ |
| V _{GS(th)} | Gate Threshold Voltage | 3.0 | | 5.5 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ |
| IDSS | Drain-to-Source Leakage Current | | ` <u> </u> | 25 | μA | $V_{DS} = 200V, V_{GS} = 0V$ |
| | | | | 250 | | $V_{DS} = 160V, V_{GS} = 0V, T_{J} = 150^{\circ}C$ |
| I _{GSS} | Gate-to-Source Forward Leakage | | | 100 | nA | $V_{GS} = 30V$ |
| | Gate-to-Source Reverse Leakage | | | -100 | | V _{GS} = -30V |

Dynamic @ $T_J = 25^{\circ}C$ (unless otherwise specified)

| | Parameter | Min. | Тур. | Max. | Units | Conditions |
|---------------------|---------------------------------|------|------|------|-------|---|
| g fs | Forward Transconductance | 6.2 | | — | S | V _{DS} = 50V, I _D = 7.8A |
| Qg | Total Gate Charge | | 25 | 38 | | I _D = 7.8A |
| Q _{gs} | Gate-to-Source Charge | | 7.3 | 11 | nC | V _{DS} = 160V |
| Q _{gd} | Gate-to-Drain ("Miller") Charge | | 12 | 18 | | V _{GS} = 10V, ④ |
| t _{d(on)} | Turn-On Delay Time | | 11 | | | V _{DD} = 100V |
| t _r | Rise Time | | 27 | | ns | I _D = 7.8A |
| t _{d(off)} | Turn-Off Delay Time | | 17 | | | $R_G = 6.8\Omega$ |
| t _f | Fall Time | | 10 | | | V _{GS} = 10V ④ |
| Ciss | Input Capacitance | | 830 | | | $V_{GS} = 0V$ |
| Coss | Output Capacitance | | 140 | | | V _{DS} = 25V |
| Crss | Reverse Transfer Capacitance | | 35 | | pF | f = 1.0MHz |
| Coss | Output Capacitance | | 990 | | | $V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$ |
| Coss | Output Capacitance | | 57 | | | $V_{GS} = 0V, V_{DS} = 160V, f = 1.0MHz$ |
| Coss eff. | Effective Output Capacitance | | 59 | | | $V_{GS} = 0V$, $V_{DS} = 0V$ to 160V \textcircled{S} |

Avalanche Characteristics

| | Parameter | Тур. | Max. | Units |
|-----------------|--|------|------|-------|
| E _{AS} | Single Pulse Avalanche Energy@ | | 130 | mJ |
| I _{AR} | Avalanche Current® | | 7.8 | A |
| E _{AR} | Repetitive Avalanche Energy ^① | | 11 | mJ |

Thermal Resistance

| | Parameter | Тур. | Max. | Units |
|------------------|----------------------------------|------|------|-------|
| R _{0JC} | Junction-to-Case | | 1.4 | |
| R _{0JA} | Junction-to-Ambient (PCB mount)* | | 50 | °C/W |
| R _{0JA} | Junction-to-Ambient | | 110 | |

Diode Characteristics

| | Parameter | Min. | Тур. | Max. | Units | Conditions | | | | | | | |
|-----------------|---------------------------|---|------|------|---------------------|---|----|----|----|----|----|--|------------------|
| Is | Continuous Source Current | | | | 13 A | MOSFET symbol | | | | | | | |
| | (Body Diode) | | | 13 | | showing the | | | | | | | |
| I _{SM} | Pulsed Source Current | | 50 | | | 52 | 50 | 50 | 50 | 50 | 50 | | integral reverse |
| | (Body Diode) ① | 5 | 52 | 52 | p-n junction diode. | | | | | | | | |
| V _{SD} | Diode Forward Voltage | | | 1.3 | V | $T_J=25^{\circ}C,\ I_S=7.8A,\ V_{GS}=0V \textcircled{9}$ | | | | | | | |
| t _{rr} | Reverse Recovery Time | | 140 | 210 | ns | $T_J = 25^{\circ}C, I_F = 7.8A$ | | | | | | | |
| Qrr | Reverse RecoveryCharge | | 750 | 1120 | nC | di/dt = 100A/µs 善 | | | | | | | |
| t _{on} | Forward Turn-On Time | Intrinsic tum-on time is negligible (tum-on is dominated by L_S+L_D) | | | | | | | | | | | |

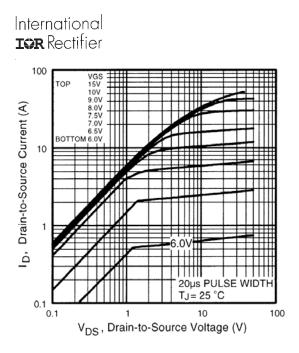


Fig 1. Typical Output Characteristics

Fig 3. Typical Transfer Characteristics

IRFR/U13N20DPbF

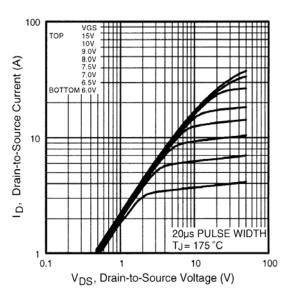


Fig 2. Typical Output Characteristics

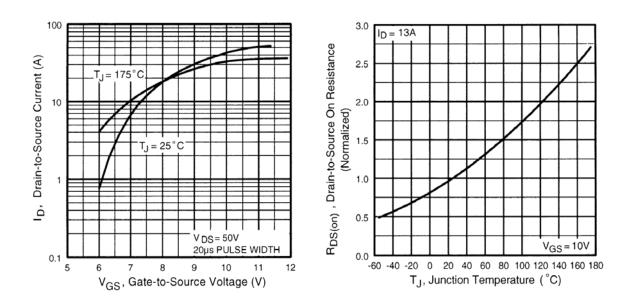
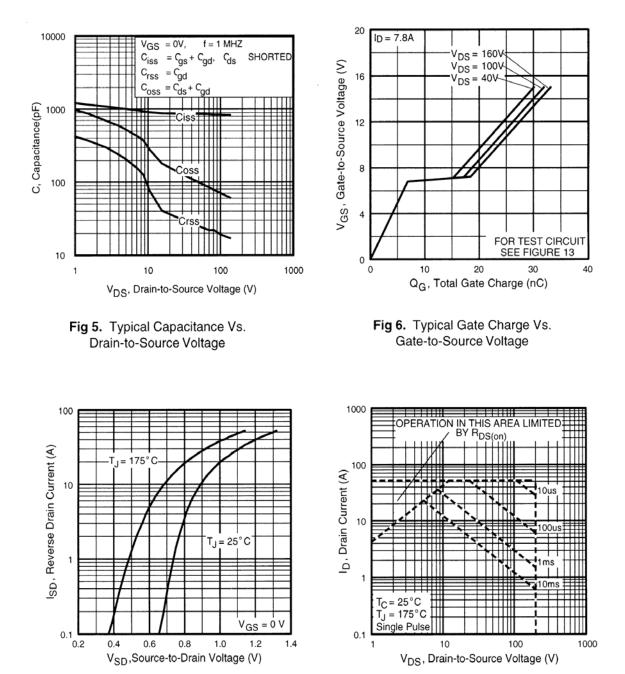


Fig 4. Normalized On-Resistance Vs. Temperature



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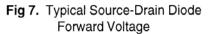
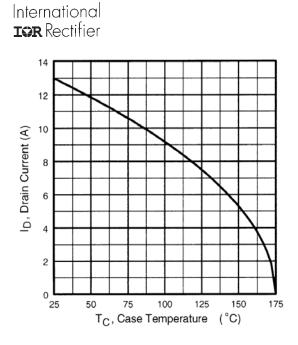
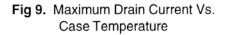


Fig 8. Maximum Safe Operating Area





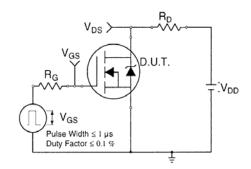


Fig 10a. Switching Time Test Circuit

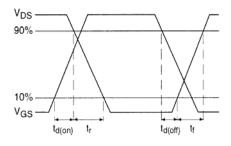


Fig 10b. Switching Time Waveforms

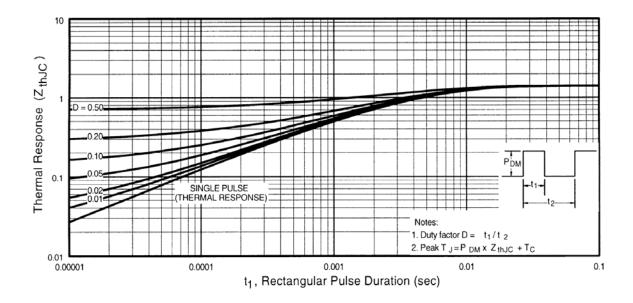
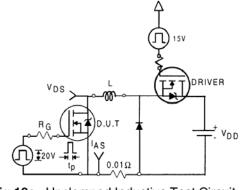
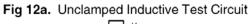


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case www.irf.com

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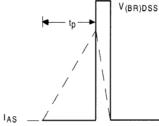


Fig 12b. | Unclamped Inductive Waveforms

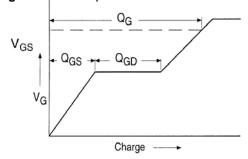


Fig 13a. Basic Gate Charge Waveform

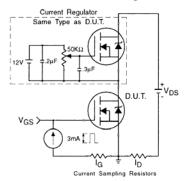


Fig 13b. Gate Charge Test Circuit 6

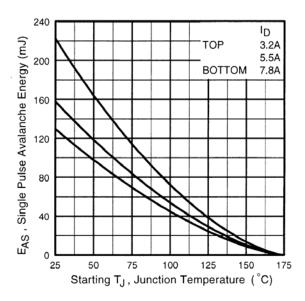
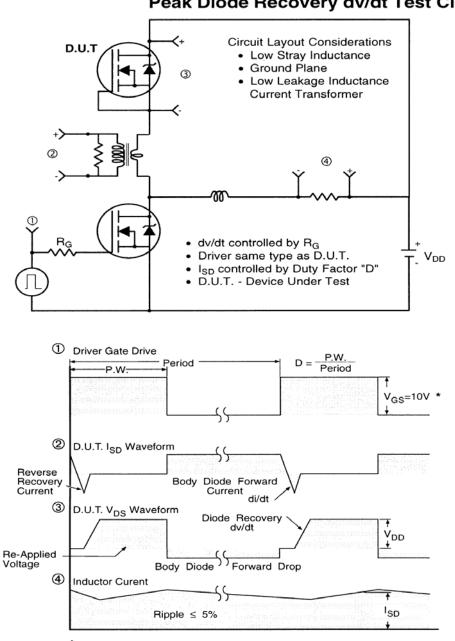


Fig 12c. Maximum Avalanche Energy Vs. Drain Current



Peak Diode Recovery dv/dt Test Circuit

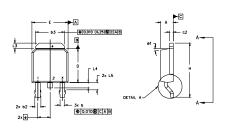
* V_{GS} = 5V for Logic Level Devices

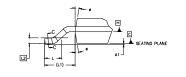
Fig 14. For N-Channel HEXFET® Power MOSFETs

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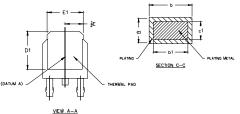
D-Pak (TO-252AA) Package Outline

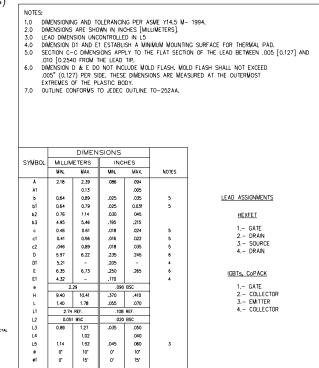
Dimensions are shown in millimeters (inches)



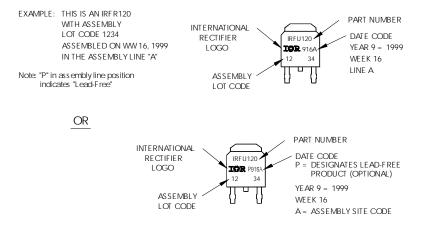


DETAIL A ROTATED 90





D-Pak (TO-252AA) Part Marking Information



International **TOR** Rectifier

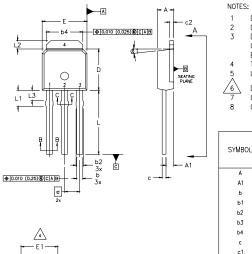
Ф

VIEW A-A

IRFR/U13N20DPbF

I-Pak (TO-251AA) Package Outline

Dimensions are shown in millimeters (inches)



(c)

0.005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY. THERMAL PAD CONTOUR OPTION WITHIN DIMENSION 64, L2, E1 & D1.

LEAD DIMENSION UNCONTROLLED IN L3.

DIMENSION 61, 63 APPLY TO BASE METAL ONLY. OUTLINE CONFORMS TO JEDEC OUTLINE TO-251AA.

DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994.

dimensions are shown in Millimeters [inches]. Dimension D & E do not include Mold Flash. Mold Flash shall not exceed

NOTES

4

3,4

3, 4

4

4

5

CONTROLLING DIMENSION : INCHES.

DIMENSIONS

INCHES

MAX

.094

0.045

0.035

0.031

0.045

0,041

0.215

0.024

0.022

0.035

0.245

0.265

0.380

0.090

0.050

0.060

15'

MIN.

0.086

0.035

0.025

0.025

0.030

0,030

0,195

0.018

0.016

0.018

0.235

0,205

0.250

0,170

0.350

0.075

0.035

0,045

0.

0.090 BSC

MILLIMETERS

MAX,

2.39

1,14

0,89

0,79

1,14

1.04

5,46

0.61

0,56

0.86

6.22

6.73

9.60

2.29

1,27

1.52

15

MIN.

2,18

0.89

0.64

0,64

0.76

0,76

5,00

0.46

0.41

.046

5.97

5.21

6,35

4.32

8.89

1.91

0.89

1,14

ď

2.29

c2

D

D1

Ε

F1

е

L L1

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L3

ø1

LEAD ASSIGNMENTS

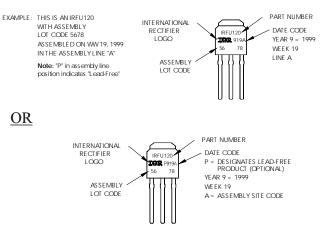
HEXFET 1.- GATE 2.- DRAIN 3.- SOURCE 4.- DRAIN

I-Pak (TO-251AA) Part Marking Information

-(b, b2)

-b1, b3·

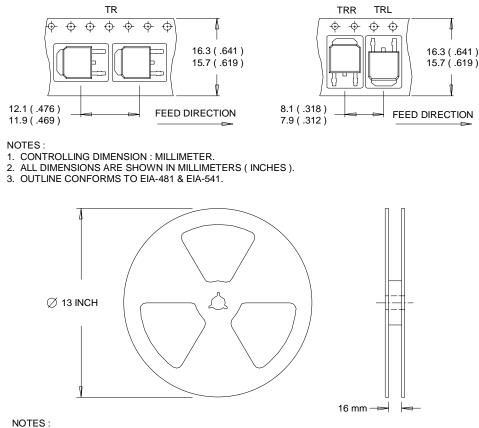
SECTION A-A



International

D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



1. OUTLINE CONFORMS TO EIA-481.

Data and specifications subject to change without notice.

International

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